

Chair of the Symposium

Margita Longauerová, Košice, Slovakia

Scientific Committee

Chairman

Ivan Hrivňák, Trnava, Slovakia

Organising Committee

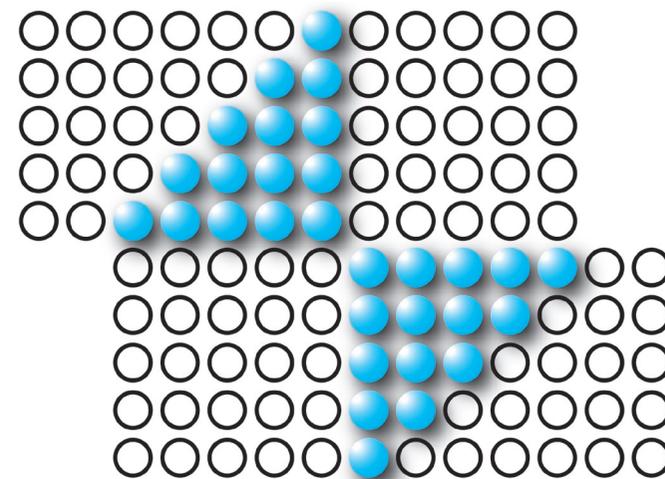
M. Longauerová Technical University of Košice, Slovakia

G. Janák (Secretary)

Proceedings

All accepted contributions will be published in a special issue of the journal Acta Metallurgica Slovaca in English language

METALLOGRAPHY 2004



Department of Materials Science, Faculty of Metallurgy,
Technical University, Košice, Slovakia

Institute of Materials Research of SAS, Košice, Slovakia

Slovak Metal Science Society

Slovak Metallurgical Society

U. S. Steel Košice, s.r.o., Research & Development Center,
Slovakia

Association of Metallurgy, Mining Industry
and Geology of the Slovak Republic

Academia Congress Centre
Stará Lesná, High Tatra Mountains

Poprad
SLOVAK REPUBLIC
28 – 30th April 2004

Scope

Metallographic conferences have a long tradition in Slovakia and Central Europe. For over 30 years they have featured as important events for presentation of results achieved in materials science, metallography, electron microscopy and allied fields. The participants come from different branches of industry, universities and academic research institutions. Exhibitions of instruments and equipment make it possible for the participants to acquaint themselves with recent achievements in research and investigation technology. Now in the new millenium we would like to expand this forum to a broader international audience to establish and improve international contacts.

Conference Topics

The structure of the 12th International Symposium on Metallography will be similar to previous conferences, but with some special sessions in areas of current interest, and will focus primarily on practical aspects and advances in

- preparation in metallography, metallographic methods and quantitative evaluation of microstructures
- electron microscopy, diffraction and microanalyses
- prediction of microstructures and interrelationships between microstructure and material properties, with no limitation to classes of materials and technology
- phase transformation
- continuous casting
- controlled rolling
- welding
- coating and corrosion
- fractures, defects and material degradation by radiation
- fatigue and creep
- nonferrous alloys
- nanostructures and nanocrystalline solids
- intermetallics
- ceramics
- powder metallurgy
- metallography in archaeology (archaeometallurgy)

Exhibition

As usual, the Symposium on Metallography will host an exhibition of metallographic and analytical equipment. Further details on exhibiting can be obtained by completing the preliminary registration form or contacting the Organiser.

Venue

This symposium traditionally takes place in the beautiful surroundings of the High Tatra Mountains. The Academia Congress Centre offers guests its services in the dining room, coffee shop, night bar, small lounges, sauna and swimming pool, and is situated near a winter sports centre. The Centre is easily accessible by road, train and bus.

Language

The official language of the conference will be English. In exceptional circumstances Slovak and Czech may also become feasible. Accepted papers are to be submitted in English language.

Call for Papers

Both oral presentation and posters are welcome, proposals for which should be submitted with a short abstract (not exceeding 200 words).

Deadlines

October 31, 2003
November 17, 2003

Abstract deadline
Acceptance notification date

January 20, 2004

Manuscript due

Organiser and Information

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SLOVAKIA

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Website: www.tuke.sk/metalo

Preliminary Registration Form

Return is requested before 31st October 2003 by mail, fax or by e-mail to the Organiser

METALLOGRAPHY 2004

12th International Symposium on Metallography

Please type or use block letters

Name:

First name:

Title:

Position:

Institute/Company:

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Address:

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ZIP Code/ City:

Country:

Phone:

Fax:

E-mail:

I would like to present a paper

I would like to present a poster

I would like to receive the second circular

I am interested in attending the Conference

I am interested in presenting and exhibiting devices

produced by our company

Title of the paper (poster)

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Date

Signature